

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Karlheinz Freywald
Serial No. : 10/588,415
Filed : July 14, 2008
Title : FILLING OF INSULATION TRENCHES USING
CMOS-STANDARD PROCESSES FOR CREATING
DIELECTRICALLY INSULATED AREAS ON A SOI DISK
Attorney Docket : LEO 009 PA
Examiner : Nguyen, Thinh T.
Art Unit : 2818
Confirm No. : 8357

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

AMENDMENT

This paper is being filed in response to the Office Action mailed February 28, 2011.
Reconsideration is respectfully requested in view of the amendments and remarks below.

Amendments to the Claims are reflected in the listing of claims, which begins
on page 2 of this paper.

Remarks/Arguments begin on page 4 of this paper.